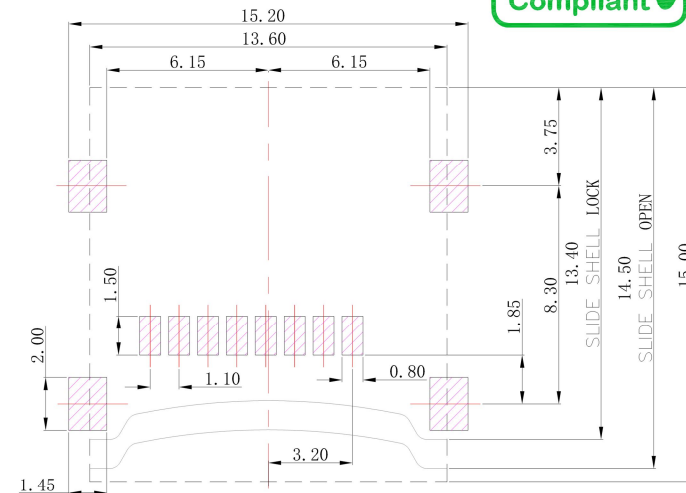
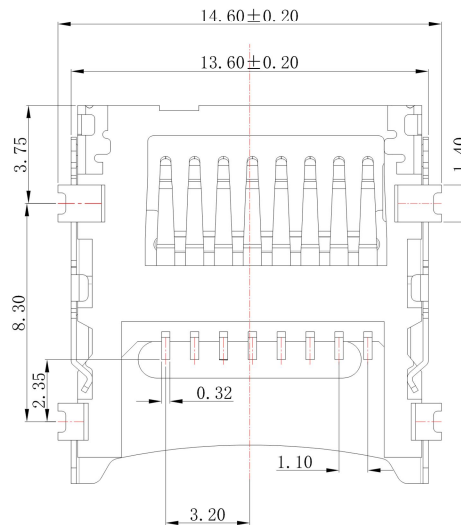
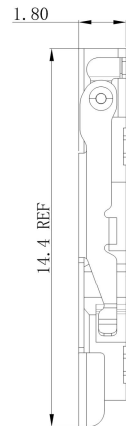
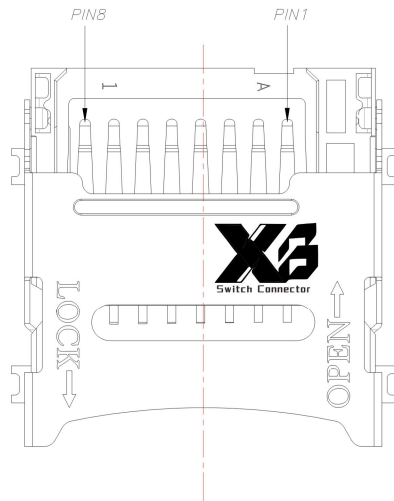




SLIDE SHELL LOCK

PCB LAYOUT

SPECIFICATION

Electrical :

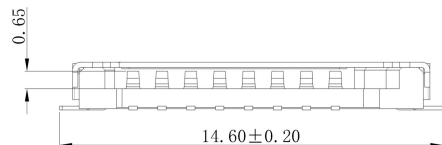
1. Rating: 0.5A
2. Contact Resistance: 50 mΩ Max.
3. Insulation Resistance: 100 MΩ Min.
4. Operating Temperature: -30°C ~85°C

Material:

1. Housing: LCP
2. Contact: Phosphor Bronze
3. Shell: SUS

Finish:

1. Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
2. Shell: Nickel under Plated surface layer



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DONG GUAN XI BANG ELECTRONICS CO., LTD.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ± 0.2
Above 5 ~ 15 ± 0.3
Above 15 ~ 30 ± 0.4
Above 30 ~ 50 ± 0.5
Angle ± 0.3°

3RD. ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao
DATE: 09/05/23

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	Micro SD 卡座 H:1.8mm
SCALE	DWG NO.	SD-TF11-41808-S267
SHEET NO.	PART NO.	SD-TF11-41808-S267

ITEM NO.	DESCRIPTION	DRAWN	DATE
5	更新圖面	Jack	090523
4	更新樣式	LAN	042419
3	更新樣式	Jack	101118
2	更新為A0版	Jack	082918
1	更新料號	Jack	081618